

Reltek BONDiT™ B-521 Adhesive, Sealant & Potting System

Category : Polymer , Adhesive , Thermoset

Material Notes:

Key Properties: Outstanding for bonding dissimilar materials with high thermal expansion differential applications. Fast thermal cure, long pot life. **Ease of use.** **Applications:** Excellent for fast assembly of dissimilar materials with large differentials in thermal expansion, such as glass to acrylic. Bonds most plastics, metals, glass, and ceramics. Cure 10 minutes at 170°F.

Order this product through the following link:

http://www.lookpolymers.com/polymer_Reltek-BONDiT-B-521-Adhesive-Sealant-Potting-System.php

| Physical Properties | Metric | English | Comments |
|---------------------|---------|---------|-------------|
| Viscosity | 2500 cP | 2500 cP | Thixotropic |

| Descriptive Properties | Value | Comments |
|------------------------|-------------|----------|
| Color | Slight haze | |

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